

10/083402
02/27/02
JAN 11

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10083402	FILING DATE 02/27/2002	CLASS 134 438	SUBCLASS 036	GAU 174 2812	EXAMINER EL ARINI
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****APPLICANTS:** Shimada Yutaka; Mori Yasuhiro; Morita Koyo; Yokoshima Kenji;

****CONTINUING DATA VERIFIED:**
None ZE

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**** FOREIGN APPLICATIONS VERIFIED:**
JAPAN 2001-259111 08/29/2001
ZE

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO
35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		XA-9629
Verified and Acknowledged Examiners's initials ZE		
TITLE : Manufacturing method of semiconductor integrated circuit device		

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G
ISSUE FEE		Primary Examiner	DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner	
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